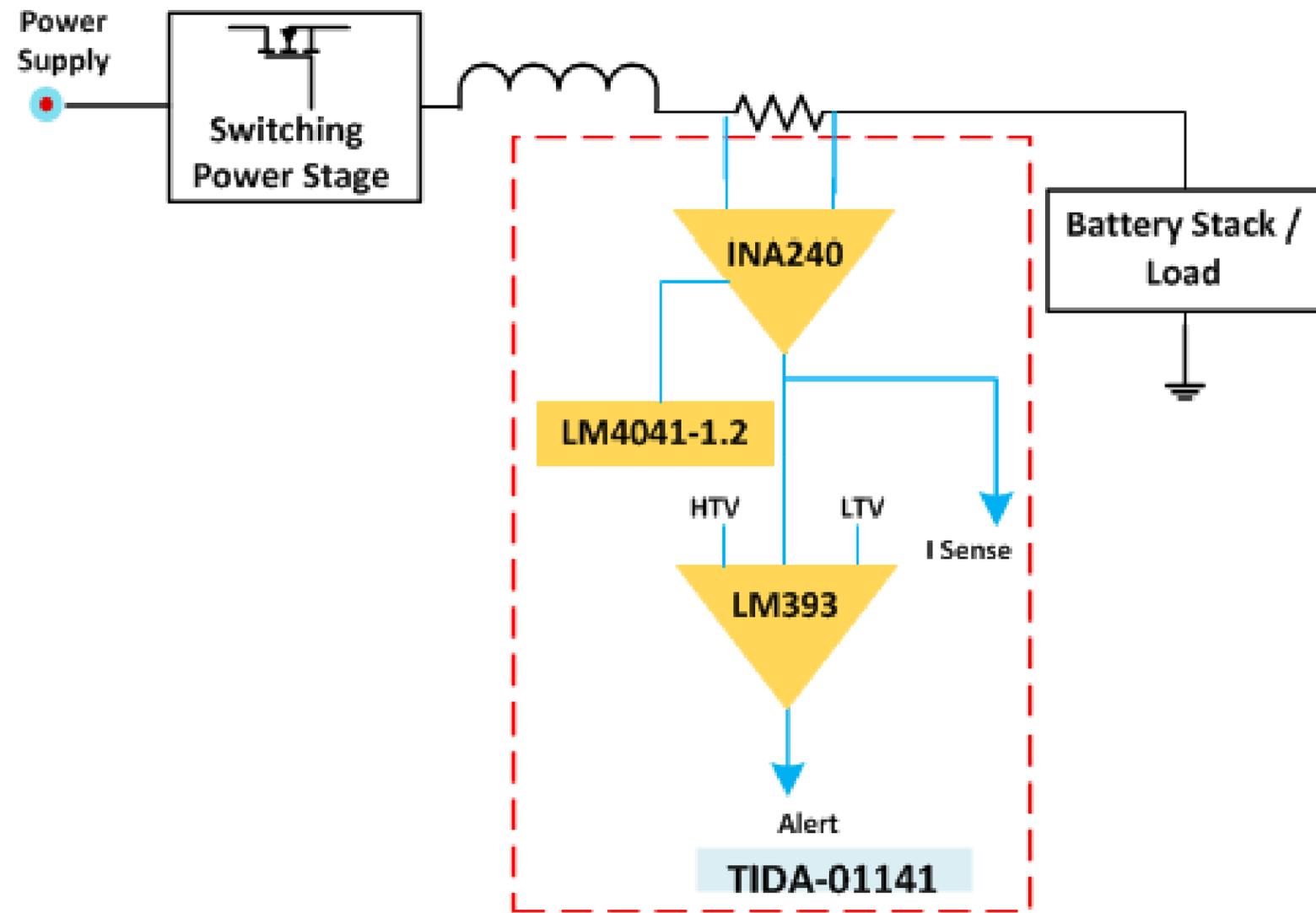


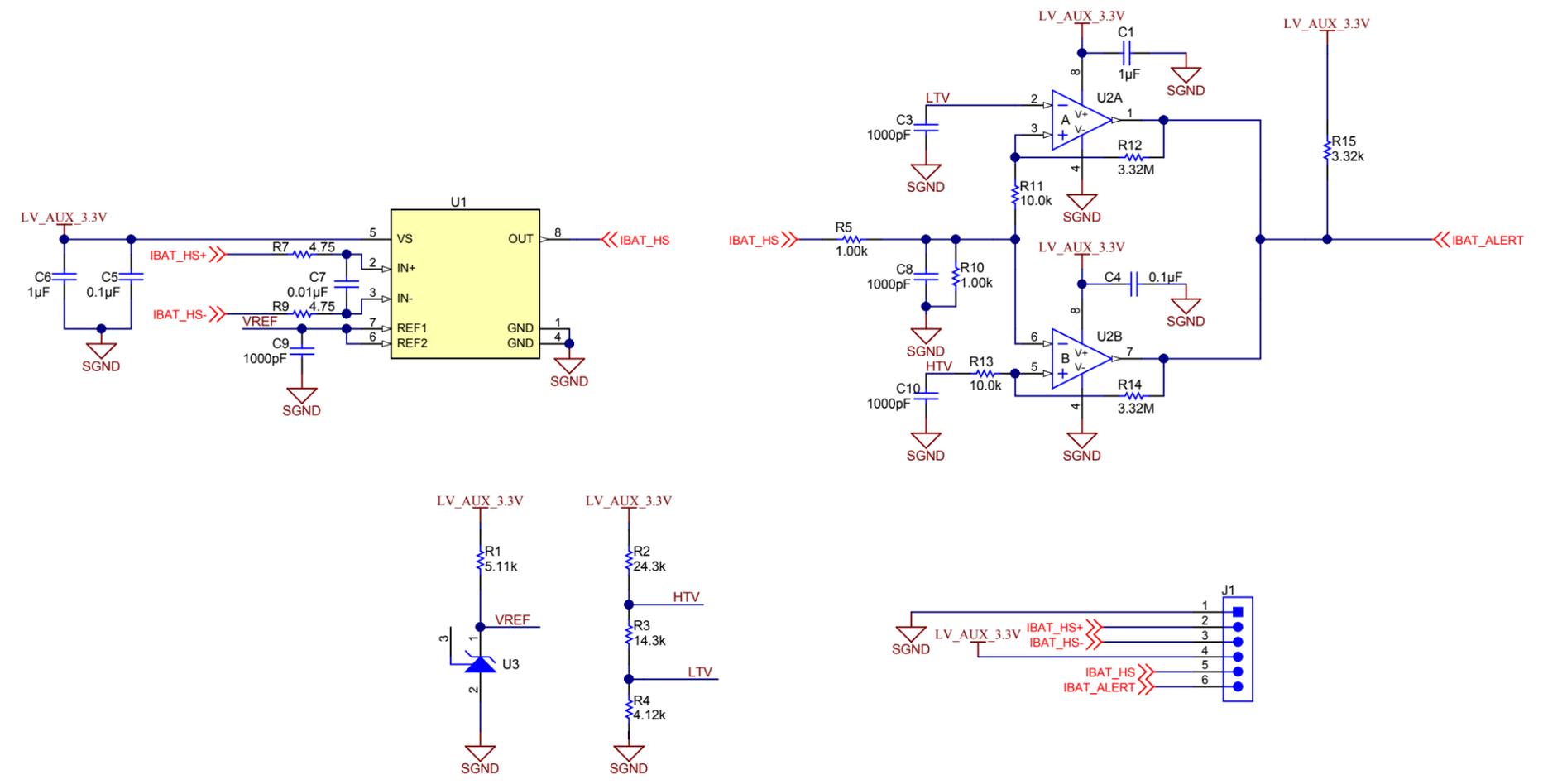
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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Orderable: N/A	Designed for: Public Release	Mod. Date: 12/8/2016	
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing	Sheet: 1 of 3	
Number: TIDA-01141	Rev: E1	File: TIDA-01141_CoverSheet_SchDoc	Size: B
SVN Rev: Version control disabled	Assembly Variant: 001	Contact: http://www.ti.com/support	© Texas Instruments 2016
Drawn By: Ramkumar S	Engineer: Ramkumar S		



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Orderable: N/A	Designed for: Public Release	Mod. Date: 12/8/2016	
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing	Sheet: 2 of 3	
Number: TIDA-01141	Rev: E1	Sheet Title:	http://www.ti.com
SVN Rev: Version control disabled	Assembly Variant: 001	File: TIDA-01141_Sheet1.SchDoc	
Drawn By: Ramkumar S	Engineer: Ramkumar S	Contact: http://www.ti.com/support	

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PCB Number: TIDA-01141
PCB Rev: E1

PCB LOGO
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PCB LOGO
Pb-Free Symbol



PCB LOGO
Logo3

^A You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Orderable: N/A	Designed for: Public Release	Mod. Date: 9/7/2016	<p>TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2016</p>
TID #: TIDA-01141	Project Title: Bi-Directional High Side Current Sensing		
Number: TIDA-01141	Rev: E1	Sheet: 3 of 3	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By:	File: TIDA-01141_Hardware.SchDoc	Size: B	
Engineer: Ramkumar S	Contact: http://www.ti.com/support		

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